ABSTRACT

A base polymer having incorporated an ester group

having a fluorinated alicyclic unit is provided. A resist composition comprising the polymer is sensitive to highenergy radiation, and has excellent sensitivity at a wavelength of less than 200 nm, significantly improved transparency by virtue of the fluorinated alicyclic units incorporated as well as satisfactory plasma etching resistance. The resist composition has a low absorption at the exposure wavelength of a F₂ laser and is ideal as a micropatterning material in VLSI fabrication.